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Express Mail No.: EV 313 841 617 US  
Date Mailed: September 12, 2003  
Application No.: 09/459,108  
Filed: December 10, 1999  
Inventor(s): Knight et al.  
For: Method and Apparatus For Non-Conductively  
Interconnecting Integrated Circuits

**Enclosed:**

- 1) Response to Office Action mailed March 12, 2003;
- 2) Petition For Extension of Time;
- 3) Notice of Appeal; and
- 2) Return Postcard.



File No.: 7828-012-999

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